

Important notice

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Should be replaced with:

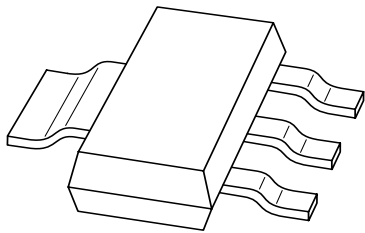
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If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via salesaddresses@nexperia.com). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

DATA SHEET



BSP19; BSP20 NPN high-voltage transistors

Product data sheet
Supersedes data of 1997 Mar 03

1999 Jun 01

NPN high-voltage transistors

BSP19; BSP20

FEATURES

- Low current (max. 100 mA)
- High voltage (max. 350 V).

APPLICATIONS

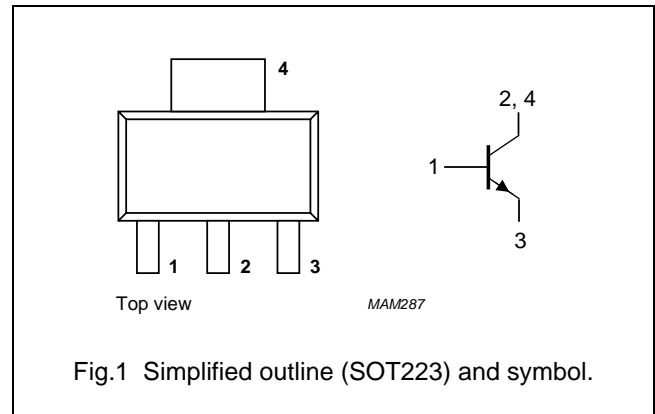
- Switching and amplification
- Especially used in telephony and automotive applications.

DESCRIPTION

NPN transistor in a SOT223 plastic package.
PNP complement: BSP16.

PINNING

| PIN | DESCRIPTION |
|------|-------------|
| 1 | base |
| 2, 4 | collector |
| 3 | emitter |



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|----------------------------------|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | | | |
| | BSP19 | | – | 400 | V |
| | BSP20 | | – | 300 | V |
| V _{CEO} | collector-emitter voltage | open base | | | |
| | BSP19 | | – | 350 | V |
| | BSP20 | | – | 250 | V |
| V _{EBO} | emitter-base voltage | open collector | – | 5 | V |
| I _C | collector current (DC) | | – | 100 | mA |
| I _B | base current (DC) | | – | 100 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; note 1 | – | 1.2 | W |
| T _{stg} | storage temperature | | –65 | +150 | °C |
| T _j | junction temperature | | – | 150 | °C |
| T _{amb} | operating ambient temperature | | –65 | +150 | °C |

Note

1. Device mounted on printed-circuit board, single sided copper, tinplated, mounting pad for collector 1 cm². For other mounting conditions, see “Thermal considerations for SOT223 in the General Part of associated Handbook”.

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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|------------|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient | note 1 | 104 | K/W |
| $R_{th\ j-s}$ | thermal resistance from junction to soldering point | | 23 | K/W |

Note

1. Device mounted on printed-circuit board, single sided copper, tinned, mounting pad for collector 1 cm².
For other mounting conditions, see "Thermal considerations for SOT223 in the General Part of associated Handbook".

CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-------------|--------------------------------------|--|------|------|------|
| I_{CBO} | collector cut-off current | $I_E = 0$; $V_{CE} = 300\text{ V}$ | – | 20 | nA |
| I_{EBO} | emitter cut-off current | $I_C = 0$; $V_{EB} = 5\text{ V}$ | – | 100 | nA |
| h_{FE} | DC current gain | $V_{CE} = 10\text{ V}$; $I_C = 20\text{ mA}$ | 40 | – | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = 50\text{ mA}$; $I_B = 4\text{ mA}$ | – | 0.5 | V |
| C_c | collector capacitance | $I_E = I_e = 0$; $V_{CB} = 10\text{ V}$; $f = 1\text{ MHz}$ | – | 2.5 | pF |
| f_T | transition frequency | $V_{CE} = 10\text{ V}$; $I_C = 10\text{ mA}$; $f = 100\text{ MHz}$ | 70 | – | MHz |

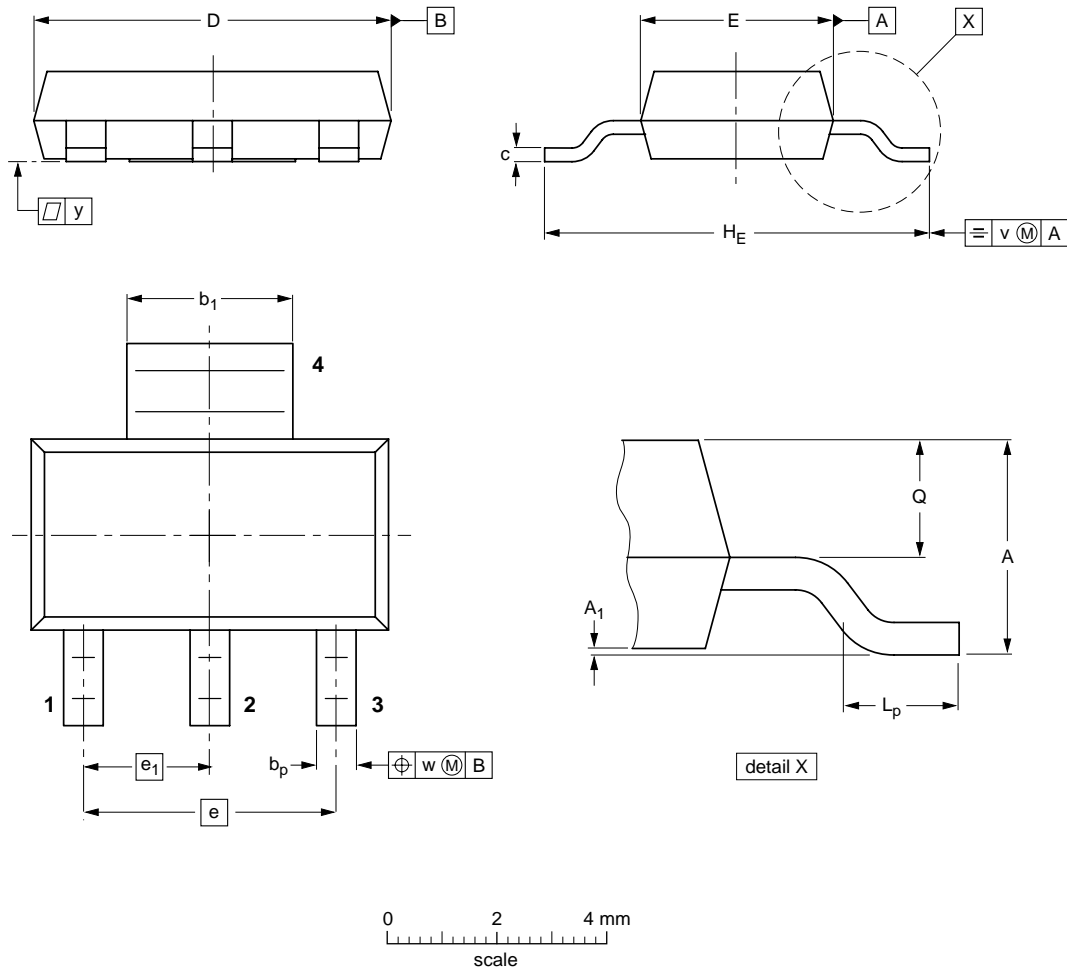
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

SOT223



DIMENSIONS (mm are the original dimensions)

| UNIT | A | A ₁ | b _p | b ₁ | c | D | E | e | e ₁ | H _E | L _p | Q | v | w | y |
|------|------------|----------------|----------------|----------------|--------------|------------|------------|-----|----------------|----------------|----------------|--------------|-----|-----|-----|
| mm | 1.8 1.5 | 0.10 0.01 | 0.80 0.60 | 3.1 2.9 | 0.32 0.22 | 6.7 6.3 | 3.7 3.3 | 4.6 | 2.3 | 7.3 6.7 | 1.1 0.7 | 0.95 0.85 | 0.2 | 0.1 | 0.1 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|-------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT223 | | | SC-73 | | | 97-02-28 99-09-13 |

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DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|--------------------------------|-------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

Notes

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2. The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: <http://www.nxp.com>

For sales offices addresses send e-mail to: salesaddresses@nxp.com

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